

SLOVENSKI STANDARD oSIST prEN IEC 63185:2024

01-julij-2024

Merjenje kompleksne permisivnosti za dielektrične podlage z nizkimi izgubami, uravnotežene z metodo krožnega diskastega resonatorja

Measurement of the complex permittivity for low-loss dielectric substrates balanced-type circular disk resonator method

Messung der komplexen Dielektrizitätskonstante für verlustarme dielektrische Substrate nach dem symmetrischen Kreisscheibenresonatorverfahren

Méthode au résonateur à disque circulaire de type symétrique pour mesurer la permittivité complexe des substrats diélectriques à faible perte

Ta slovenski standard je istoveten z: prEN IEC 63185:2024

slovelen z. pren iec 831

ICS:

33.120.30 Radiofrekvenčni konektorji RF connectors (RF)

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46F/672/CDV

COMMITTEE DRAFT FOR VOTE (CDV)

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United States of America	Mr John Morelli			
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FUNCTIONS CONCERNED:				
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TITLE:

Measurement of the complex permittivity for low-loss dielectric substrates balanced-type circular disk resonator method

PROPOSED STABILITY DATE: 2027

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3	34		MEAS	JREMENT OF THE	COMPLEX PERMIT	TIVITY				
	35	FOR LOW-LOSS DIELECTRIC SUBSTRATES								
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